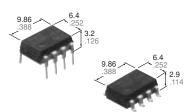
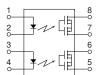


General use and economy type. DIP (2 Form B) 8-pin type. Reinforced insulation 5,000V type.



mm inch



FEATURES

1. Reinforced insulation 5,000 V type More than 0.4 mm internal insulation distance between inputs and outputs. Con-forms to EN41003, EN60950 (reinforced insulation).

2. Compact 8-pin DIP size The device comes in a compact (W)6.4×(L)9.86×(H)3.2 mm (W).252×(L).388×(H).126 inch, 8-pin DIP size (through hole terminal type).

3. Applicable for 2 Form B use as well as two independent 1 Form B use

4. Controls low-level analog signals PhotoMOS relays feature extremely low closed-circuit offset voltage to enable control of low-level analog signals without distortion.

GU-E PhotoMOS

(AQW414EH)

5. High sensitivity, high speed response.

Can control a maximum 0.13 A load current with a 5 mA input current. Fast operation speed of 0.8 ms (typical).

6. Low-level off state leakage current

TYPICAL APPLICATIONS

Modem

- Telephone equipment
- Security equipment
- Sensors

TYPES

Туре	I/O isolation voltage	Output rating*		Part No.					
				Through hole terminal	Surface-mount terminal			Packing quantity	
		Lood	Laad			Tape and reel packing style			Tana and
		Load voltage	Load current	Tube pac	king style	Picked from the 1/2/3/4-pin side	Picked from the 5/6/7/8-pin side	Tube	Tape and reel
AC/DC type	Reinforced 5,000 V	400 V	100 mA	AQW414EH	AQW414EHA	AQW414EHAX	AQW414EHAZ	1 tube contains 40 pcs. 1 batch contains 400 pcs.	1,000 pcs.

*Indicate the peak AC and DC values.

Note:

For space reasons, the SMD terminal shape indicator "A" and the package type indicator "X" and "Z" are omitted from the seal.

RATING

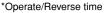
1. Absolute maximum ratings (Ambient temperature: 25°C 77°F)

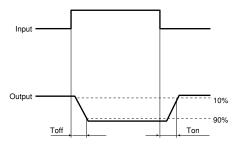
Item		Symbol	AQW414EH (A)	Remarks	
	LED forward current	lF	50mA		
Input	LED reverse voltage	VR	5V		
	Peak forward current	IFP	1A	f =100 Hz, Duty factor = 0.1%	
	Power dissipation	Pin	75mW		
Output	Load voltage (peak AC)	VL	400 V		
	Continuous load current	IL I	0.1 A (0.13 A)	Peak AC, DC (): in case of using only 1 channel.	
	Peak load current	Ipeak	0.3 A	100 ms (1 shot), VL= DC	
	Power dissipation	Pout	800mW		
Total power dissipation		Рт	850mW		
I/O isolation voltage		Viso	5,000 V AC		
Tempera	ature Operating	Topr	−40°C to +85°C −40°F to +185°F	Non-condensing at low temperatures	
limits	Storage	Tstg	-40°C to +100°C -40°F to +212°F		

	Item		Symbol	AQW414EH (A)	Condition	
	LED operate (OFF)	Typical	1.3mA	L Mox		
	current	Maximum	Foff	3.0mA	I∟=Max.	
laput	LED reverse (ON)	Minimum	Fon	0.4mA	I∟=Max.	
Input	current	Typical		1.2mA	IL=Max.	
	LED dropout voltage	Typical	VF	1.25 (1.14 V at I⊧=5mA)	I⊧=50mA	
	LED dropout voltage	Maximum		1.5V		
	On mariatana a	Typical	Ron	26Ω	l⊧=0mA I∟=Max. Within 1 s on time	
Output	On resistance	Maximum		35Ω		
	Off state leakage current	Maximum	ILeak	10μΑ	l⊧=5mA V∟=Max.	
	Turn on time*	Typical	T _{off}	0.8ms	I⊧=0mA→5mA	
	ium on ume	Maximum	loff	3.0ms	I∟=Max.	
	Turn off time*	Typical	т	0.2ms	I⊧=5mA→0mA	
ansfer charac-		Maximum	Ton	1.0ms	I∟=Max.	
teristics		Typical	Ciso	0.8pF	f =1MHz	
	I/O capacitance	Maximum	Ciso	1.5pF	V _B =0V	
	Initial I/O isolation resistance	Minimum	Riso	1,000ΜΩ	500V DC	

Note: Recommendable LED forward current IF= 5 to 10mA.

For type of connection

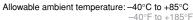


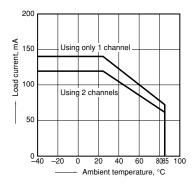


For Dimensions
For Schematic and Wiring Diagrams
For Cautions for Use

REFERENCE DATA

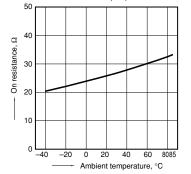
1. Load current vs. ambient temperature characteristics





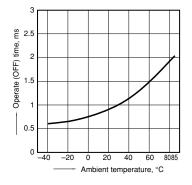
2. On resistance vs. ambient temperature characteristics

Measured portion: between terminals 5 and 6, 7 and 8; LED current: 0 mA; Load voltage: Max. (DC); Continuous load current: Max. (DC)



3. Operate (OFF) time vs. ambient temperature characteristics

LED current: 5 mA; Load voltage: Max. (DC); Continuous load current: Max. (DC)

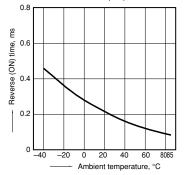


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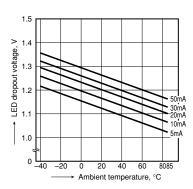
GU-E PhotoMOS (AQW414EH)

4. Reverse (ON) time vs. ambient temperature characteristics

LED current: 5 mA; Load voltage: Max. (DC); Continuous load current: Max. (DC)

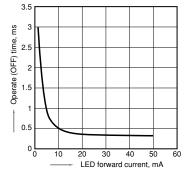


7. LED dropout voltage vs. ambient temperature characteristics; LED current: 5 to 50 mA



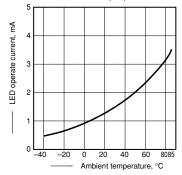
10. Operate (OFF) time vs. LED forward current characteristics

Measured portion: between terminals 5 and 6, 7 and 8; Load voltage: Max. (DC); Continuous load current: Max. (DC); Ambient temperature: $25^{\circ}C$ $77^{\circ}F$



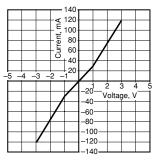
5. LED operate current vs. ambient temperature characteristics Load voltage: Max. (DC);

Continuous load current: Max. (DC)



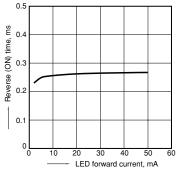
8. Current vs. voltage characteristics of output at MOS portion

Measured portion: between terminals 5 and 6, 7 and 8; Ambient temperature: 25°C 77°F



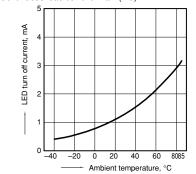
11. Reverse (ON) time vs. LED forward current characteristics

Measured portion: between terminals 5 and 6, 7 and 8; Load voltage: Max. (DC); Continuous load current: Max. (DC); Ambient temperature: $25^{\circ}C$ 77°F



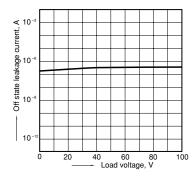
6. LED turn off current vs. ambient temperature characteristics

Load voltage: Max. (DC); Continuous load current: Max. (DC)



9. Off state leakage current vs. load voltage characteristics

Measured portion: between terminals 5 and 6, 7 and 8; Ambient temperature: 25°C 77°F



12. Output capacitance vs. applied voltage characteristics

Measured portion: between terminals 5 and 6, 7 and 8; Frequency: 1 MHz; Ambient temperature: 25°C 77°F

